

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- Green Device Available

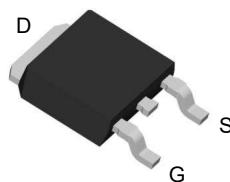
Product Summary



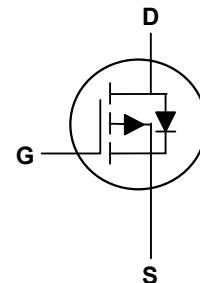
V_{DS}	-40	V
I_D	-15	A
$R_{DS(ON)}$ (at $V_{GS}=-10V$)	36	mΩ
$R_{DS(ON)}$ (at $V_{GS}=-4.5V$)	52	mΩ

Applications

- High Frequency Point-of-Load, Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- CCFL Back-light Inverter



TO-252 Top View



Absolute Maximum Ratings($T_c=25^\circ C$, unless otherwise noted)

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V_{DS}	-40	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	$I_D @ T_c = 25^\circ C$	-15	A
Continuous Drain Current	$I_D @ T_c = 100^\circ C$	-10	A
Pulsed Drain Current ²	I_{DM}	-80	A
Total Power Dissipation ³	$P_D @ T_c = 25^\circ C$	37.5	W
Total Power Dissipation ³	$P_D @ T_c = 100^\circ C$	19	W
Storage Temperature Range	T_{STG}	-55 to 175	°C
Operating Junction Temperature Range	T_J	-55 to 175	°C

Thermal Characteristics

Parameter	Symbol	Typ	Max	Unit
Thermal Resistance Junction-Case ¹	$R_{\theta JC}$	---	4	°C/W

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}$, $I_D=-250\mu\text{A}$	-40	---	---	V
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}}=-10\text{V}$, $I_D=-20\text{A}$	---	25	36	$\text{m}\Omega$
		$V_{\text{GS}}=-4.5\text{V}$, $I_D=-10\text{A}$	---	42	52	$\text{m}\Omega$
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{GS}}=V_{\text{DS}}$, $I_D = -250\mu\text{A}$	-1	-2	-3	V
Drain-Source Leakage Current	I_{DSS}	$V_{\text{DS}}=-32\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=25^\circ\text{C}$	---	---	-1	uA
		$V_{\text{DS}}=-32\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=55^\circ\text{C}$	---	---	-5	uA
Gate-Source Leakage Current	I_{GSS}	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	± 100	nA
Forward Transconductance	g_{fs}	$V_{\text{DS}}=-5\text{V}$, $I_D=-10\text{A}$	---	25	---	S
Total Gate Charge	Q_g	$V_{\text{DS}}=-20\text{V}$, $V_{\text{GS}}=-10\text{V}$, $I_D=15\text{A}$	---	20	---	nC
Gate-Source Charge	Q_{gs}		---	2.5	---	
Gate-Drain Charge	Q_{gd}		---	4.5	---	
Turn-On Delay Time	$T_{\text{d}(\text{on})}$	$V_{\text{DS}}=-20\text{V}$, $V_{\text{GS}}=-10\text{V}$, $R_L=1.6\Omega$, $R_G=3\Omega$	---	5	---	ns
Rise Time	T_r		---	12	---	
Turn-Off Delay Time	$T_{\text{d}(\text{off})}$		---	20	---	
Fall Time	T_f		---	4.5	---	
Input Capacitance	C_{iss}	$V_{\text{DS}}=-25\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$	---	840	---	pF
Output Capacitance	C_{oss}		---	92	---	
Reverse Transfer Capacitance	C_{rss}		---	60	---	

Drain-Source Diode Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Continuous Source Current ^{1,4}	I_s	$V_G=V_D=0\text{V}$, Force Current	---	---	-20	A
Diode Forward Voltage ²	V_{SD}	$V_{\text{GS}}=0\text{V}$, $I_s=-20\text{A}$, $T_J=25^\circ\text{C}$	---	---	-1.2	V

Note:

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$
- 3.The power dissipation is limited by 175°C junction temperature
- 4.The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.

Typical Characteristics

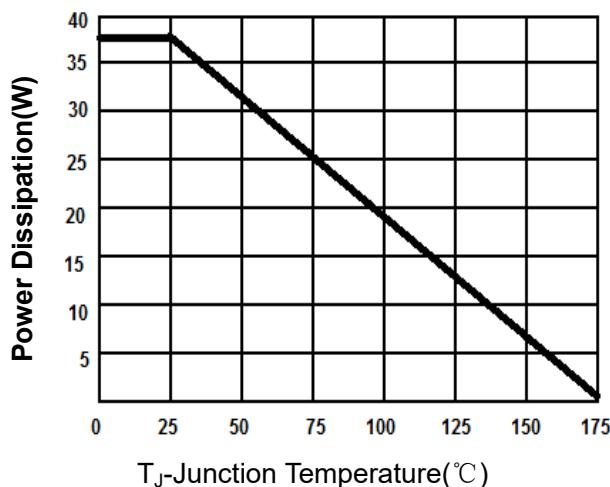
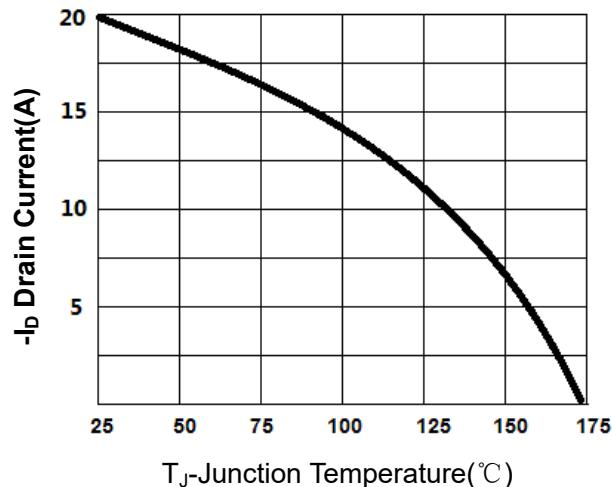


Figure 1 Power Dissipation



T_j-Junction Temperature(°C)

Figure 2 Drain Current

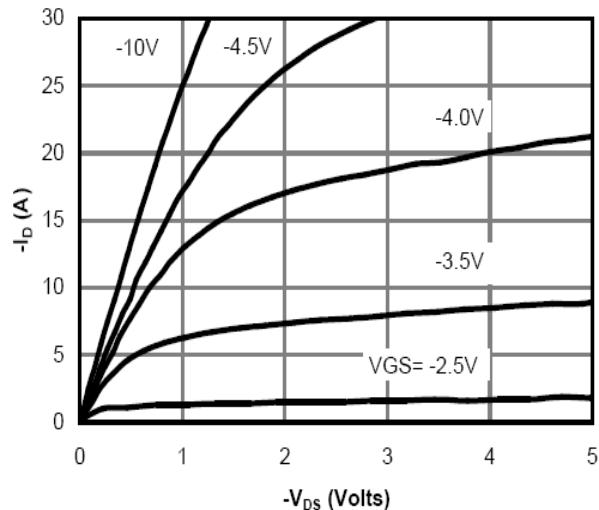


Figure 3 Output Characteristics

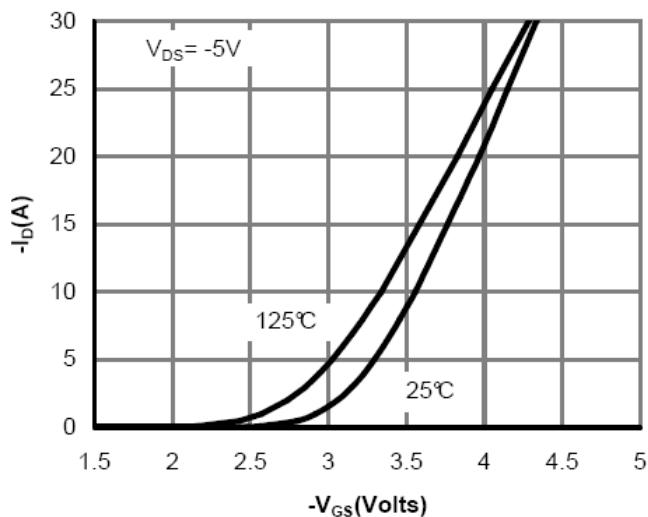


Figure 4 Transfer Characteristics

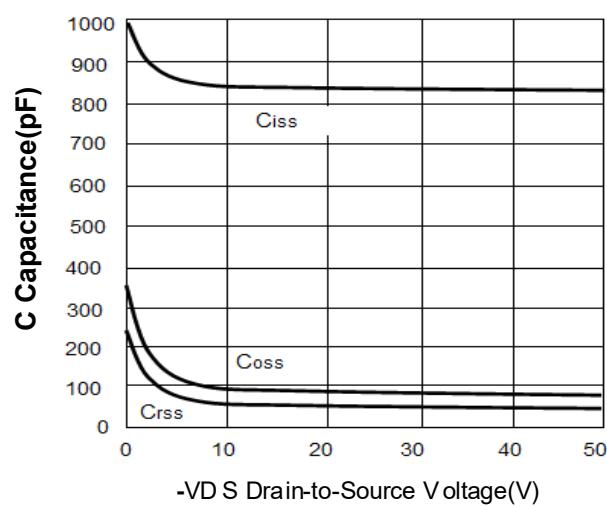


Figure 5. Capacitance

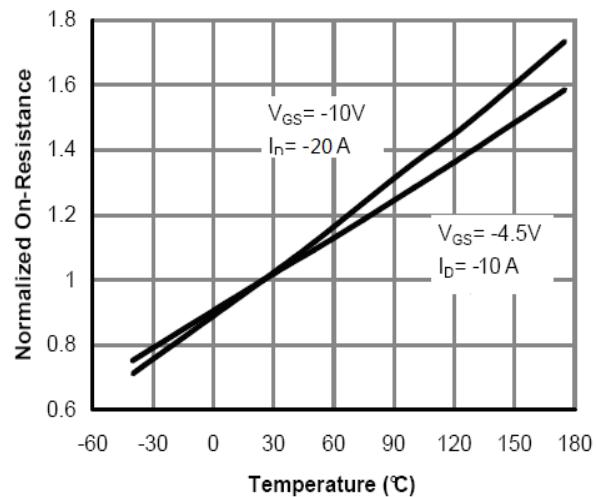


Figure 6. R_{DS(ON)} vs Junction Temperature

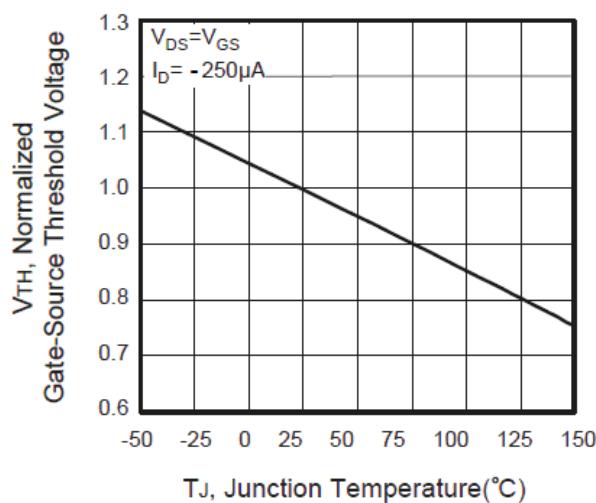


Figure 7. $V_{GS(th)}$ vs Junction Temperature

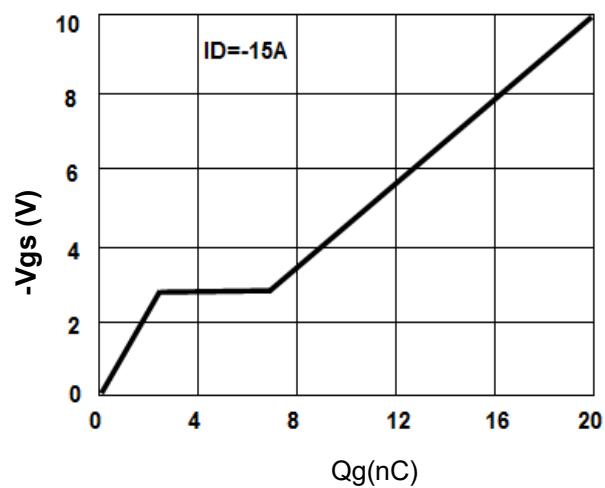


Figure 8. Gate Charge Waveforms

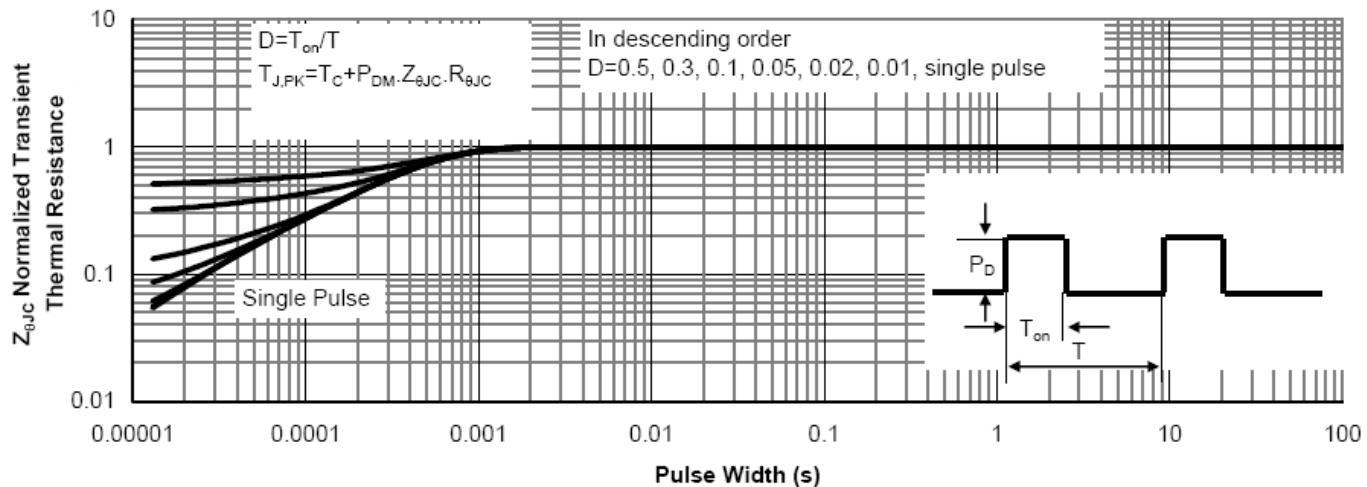
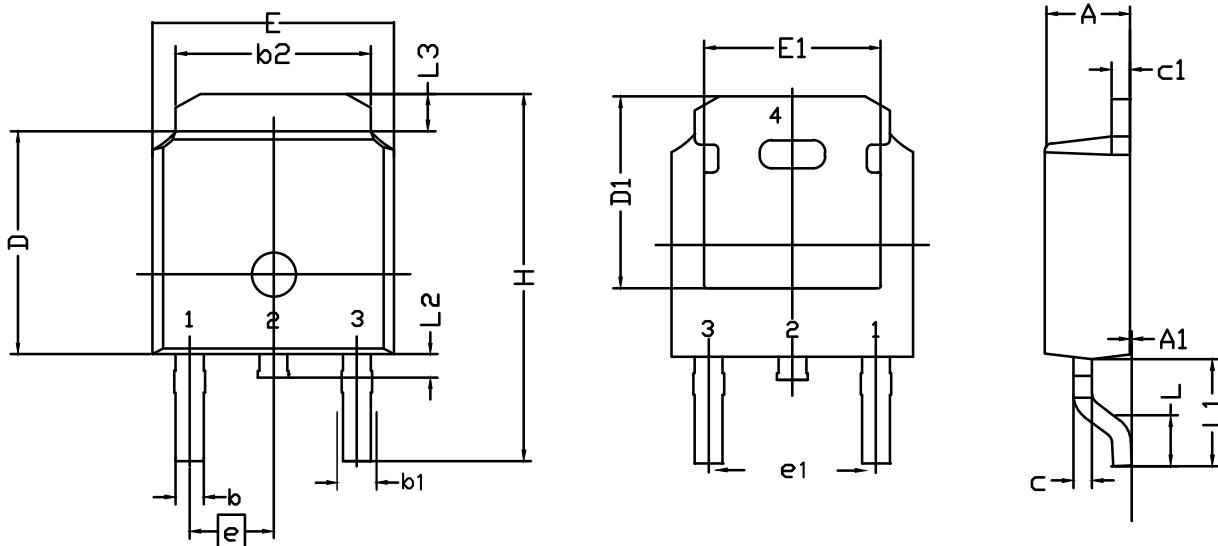


Figure 9. Normalized Maximum Transient Thermal Impedance

TO-252 Package Outline Dimensions



Symbol	Dimensions (unit:mm)			Symbol	Dimensions (unit:mm)		
	Min	Typ	Max		Min	Typ	Max
A	2.20	2.30	2.38	E	6.40	6.60	6.731
A₁	0.00	0.10	0.20	E₁	4.40	--	--
b	0.64	0.76	0.89	e	2.286 BSC		
b₁	0.77	0.85	1.14	e₁	4.572 BSC		
b₂	5.00	5.33	5.46	H	9.40	10.00	10.40
c	0.458	0.508	0.610	L	1.40	1.52	1.77
C₁	0.458	0.508	0.620	L₁	--	2.743	--
D	5.98	6.10	6.223	L₂	0.60	0.80	1.01
D₁	5.20	5.25	5.38	L₃	0.90	1.06	1.25